# onsemi

#### DATA SHEET www.onsemi.com

## **Octal Buffer/Line Driver** with 3-State Outputs

# **MC74ACT241**

The MC74ACT241 is an octal buffer and line driver designed to be employed as a memory address driver, clock driver and bus oriented transmitter or receiver which provides improved PC board density.

#### Features

- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- Outputs Source/Sink 24 mA
- TTL Compatible Inputs
- These are Pb-Free Devices

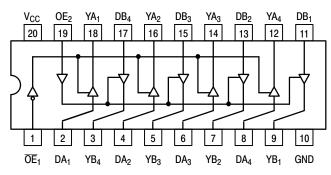


Figure 1. Pinout: 20–Lead Packages Conductors (Top View)

#### TRUTH TABLE

Inputs		Outputs
OE <sub>1</sub>	D	(Pins 12, 14, 16, 18)
L	L	L
L	Н	н
Н	Х	Z

H = HIGH Voltage Level

- L = LOW Voltage Level
- X = Immaterial

Z = High Impedance

#### TRUTH TABLE

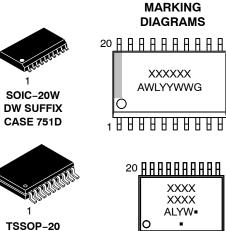
Inputs		Outputs
OE <sub>2</sub> D		(Pins 3, 5, 7, 9)
н	L	L
н	Н	Н
L	Х	Z

H = HIGH Voltage Level

- L = LOW Voltage Level
- X = Immaterial

Z = High Impedance

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TSSOP-20 DT SUFFIX CASE 948E

XXXXXX	= Specific Device Code
А	= Assembly Location
WL, L	= Wafer Lot
YY, Y	= Year
WW, W	= Work Week
G or ∎	= Pb-Free Package
(Note: Microde	ot may be in either location)

#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

#### MAXIMUM RATINGS

Symbol	Pa	rameter	Value	Unit
V <sub>CC</sub>	DC Supply Voltage (Referenced to GN	D)	-0.5 to +6.5	V
V <sub>IN</sub>	DC Input Voltage (Referenced to GND)		–0.5 to V <sub>CC</sub> +0.5	V
V <sub>OUT</sub>	DC Output Voltage (Referenced to GN	D) (Note 1)	–0.5 to V <sub>CC</sub> +0.5	V
Ι <sub>ΙΚ</sub>	DC Input Diode Current		±20	mA
I <sub>OK</sub>	DC Output Diode Current	±50	mA	
I <sub>OUT</sub>	DC Output Sink/Source Current	±50	mA	
I <sub>CC</sub>	DC Supply Current, per Output Pin	±50	mA	
I <sub>GND</sub>	DC Ground Current, per Output Pin	±100	mA	
T <sub>STG</sub>	Storage Temperature Range		-65 to +150	°C
ΤL	Lead temperature, 1 mm from Case for	10 Seconds	260	°C
TJ	Junction Temperature Under Bias		140	°C
$\theta_{JA}$	Thermal Resistance (Note 2)	SOIC TSSOP	96 150	°C/W
MSL	Moisture Sensitivity		Level 1	
F <sub>R</sub>	Flammability Rating	Oxygen Index: 30% – 35%	UL 94 V-0 @ 0.125 in	
$V_{\text{ESD}}$	ESD Withstand Voltage	Human Body Model (Note 3) Charged Device Model (Note 4)	> 2000 > 1000	V
I <sub>Latchup</sub>	Latchup Performance A	bove $V_{CC}$ and Below GND at 85°C (Note 5)	±100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. IOUT absolute maximum rating must be observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.

3. Tested to EIA/JESD22-A114-A.

4. Tested to JESD22-C101-A.

5. Tested to EIA/JESD78.

#### **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter	Min	Тур	Max	Unit
V <sub>CC</sub>	DC Input Voltage (Referenced to GND)			5.5	V
V <sub>IN</sub> , V <sub>OUT</sub>	DC Input Voltage, Output Voltage (Referenced to GND)	0		V <sub>CC</sub>	V
T <sub>A</sub>	Operating Temperature, All Package Types	-40	25	+85	°C
t <sub>r</sub> , t <sub>f</sub>	Input Rise and Fall Time (Note 7) $ \begin{array}{c} V_{CC} = 4.5 \ V \\ V_{CC} = 5.5 \ V \end{array} $		10 8.0	10 8.0	ns/V
I <sub>OH</sub>	Output Current – High	-	-	-24	mA
I <sub>OL</sub>	Output Current – Low	-	-	24	mA

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.
Unused Inputs may not be left open. All inputs must be tied to a high voltage level or low logic voltage level.
V<sub>in</sub> from 0.8 V to 2.0 V; refer to individual Data Sheets for devices that differ from the typical input rise and fall times.

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#### **DC CHARACTERISTICS**

		Vcc	<b>T</b> <sub>A</sub> = -	⊦25°C	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		
Symbol	Parameter			uaranteed Limits	Unit	Conditions	
V <sub>IH</sub>	Minimum High Level Input Voltage	4.5 5.5	1.5 1.5	2.0 2.0	2.0 2.0	V V	$V_{OUT} = 0.1 V \text{ or}$ $V_{CC} - 0.1 V$
V <sub>IL</sub>	Maximum Low Level Input Voltage	4.5 5.5	1.5 1.5	0.8 0.8	0.8 0.8	V V	$V_{OUT} = 0.1 \text{ V or}$ $V_{CC} - 0.1 \text{ V}$
V <sub>OH</sub>	Minimum High Level Output Voltage	4.5 5.5	4.49 5.49	4.4 5.4	4.4 5.4	V V	I <sub>OUT</sub> = -50 μA
		4.5 5.5	-	3.86 4.86	3.76 4.76	V V	$\label{eq:VIN} \begin{array}{ll} {}^{*}V_{IN} = V_{IL} \text{ or } V_{IH} & -24 \text{ mA} \\ I_{OH} & -24 \text{ mA} \end{array}$
V <sub>OL</sub>	Maximum Low Level Output Voltage	4.5 5.5	0.001 0.001	0.1 0.1	0.1 0.1	V V	I <sub>OUT</sub> = 50 μA
		4.5 5.5	-	0.36 0.36	0.44 0.44	V V	
I <sub>IN</sub>	Maximum Input Leakage Current	5.5	-	±0.1	±1.0	μA	V <sub>I</sub> = V <sub>CC</sub> , GND
$\Delta I_{CCT}$	Additional Maximum I <sub>CC</sub> /Input	5.5	0.6	_	1.5	mA	$V_{I} = V_{CC} - 2.1 V$
I <sub>OZ</sub>	Maximum 3-State Current	5.5	-	±0.5	±5.0	μA	$ \begin{array}{l} V_{I} \; (OE) = V_{IL}, \; V_{IH} \\ V_{I} = V_{CC}, \; GND \\ V_{O} = V_{CC}, \; GND \end{array} $
I <sub>OLD</sub> I <sub>OHD</sub>	†Minimum Dynamic Output Current	5.5 5.5	-	-	75 -75	mA mA	V <sub>OLD</sub> = 1.65 V Max V <sub>OHD</sub> = 3.85 V Min
I <sub>CC</sub>	Maximum Quiescent Supply Current	5.5	-	8.0	80	μA	V <sub>IN</sub> = V <sub>CC</sub> or GND

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. \*All outputs loaded; thresholds on input associated with output under test.

†Maximum test duration 2.0 ms, one output loaded at a time.

#### AC CHARACTERISTICS $t_r = t_f = 3.0 \text{ ns}$ (For Figures and Waveforms, See Figures 2, 3, and 4.)

		V <sub>CC</sub> *	$T_{A} = +25^{\circ}C$ $C_{L} = 50 \text{ pF}$		T <sub>A</sub> = -40°C to +85°C C <sub>L</sub> = 50 pF			
Symbol	Parameter	(V)	Min	Тур	Max	Min	Max	Unit
t <sub>PLH</sub>	Propagation Delay Data to Output	5.0	1.5	6.5	9.0	1.5	10.0	ns
t <sub>PHL</sub>	Propagation Delay Data to Output	5.0	1.5	7.0	9.0	1.5	10.0	ns
t <sub>PZH</sub>	Output Enable Time	5.0	1.5	6.0	9.0	1.0	10.0	ns
t <sub>PZL</sub>	Output Enable Time	5.0	1.5	7.0	10.0	1.5	11.0	ns
t <sub>PHZ</sub>	Output Disable Time	5.0	1.5	8.0	10.5	1.5	11.5	ns
t <sub>PLZ</sub>	Output Disable Time	5.0	2.0	7.0	10.5	1.5	11.5	ns

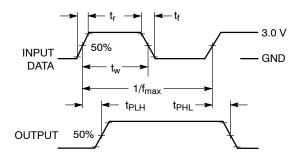
\*Voltage Range 5.0 V is 5.0 V  $\pm 0.5$  V

#### CAPACITANCE

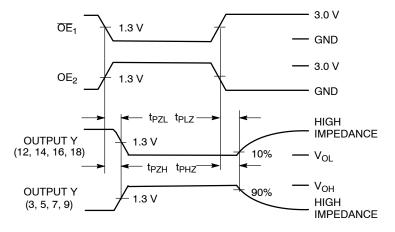
Symbol	Parameter		Unit	Test Conditions
C <sub>IN</sub>	Input Capacitance		pF	V <sub>CC</sub> = 5.0 V
C <sub>PD</sub>	Power Dissipation Capacitance		pF	V <sub>CC</sub> = 5.0 V

#### MC74ACT241

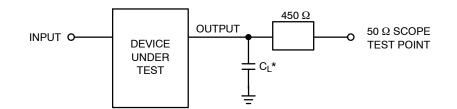
#### SWITCHING WAVEFORMS











\*Includes all probe and jig capacitance

Figure 4. Test Circuit

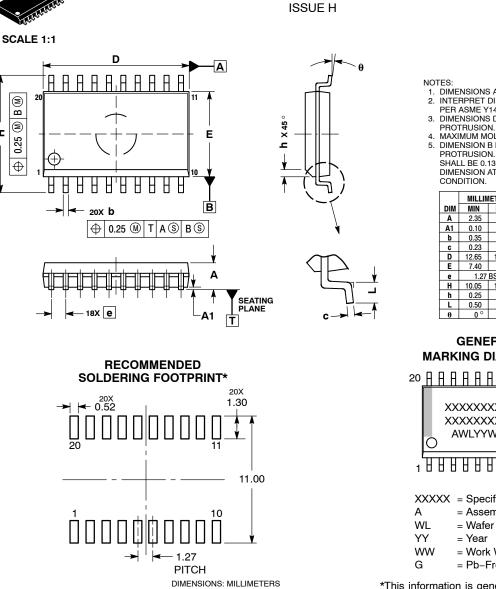
### MC74ACT241

#### **ORDERING INFORMATION**

Device	Marking	Package	Shipping <sup>†</sup>
MC74ACT241DWR2G	ACT241	SOIC-20	1000 / Tape & Reel
MC74ACT241DTR2G	ACT 241	TSSOP-20	2500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

т



SOIC-20 WB CASE 751D-05

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

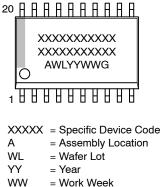
DATE 22 APR 2015

DUSEM

- 1. DIMENSIONS ARE IN MILLIMETERS. 2. INTERPRET DIMENSIONS AND TOLERANCES
- PER ASME Y14.5M, 1994. 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
- DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL

	MILLIMETERS				
DIM	MIN	MAX			
Α	2.35	2.65			
A1	0.10	0.25			
b	0.35	0.49			
C	0.23	0.32			
D	12.65	12.95			
E	7.40	7.60			
е	1.27	BSC			
Н	10.05	10.55			
h	0.25	0.75			
L	0.50	0.90			
θ	0 °	7 °			

GENERIC **MARKING DIAGRAM\*** 

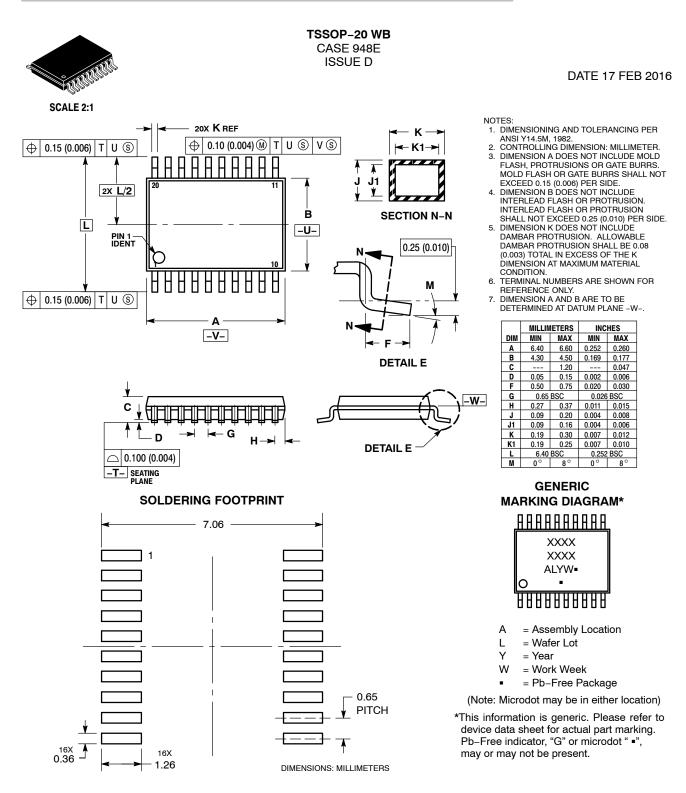


= Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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